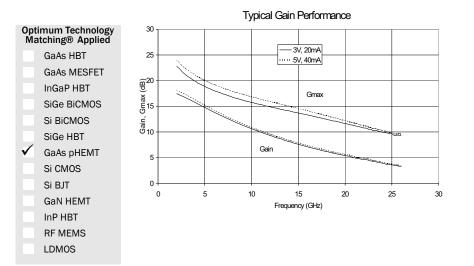




Product Description

RFMD's SPF-2000 is a high linearity. low noise 0.25µm pHEMT. This 300 µm device is ideally biased at 3V, 20 mA for lowest noise performance. At 5V, 40mA the device delivers excellent output TOI of 32dBm. It provides ideal performance as driver stages in many commercial, industrial, and military LNA applications.



Features

- 15dB G_{MAX} at 12GHz
- 1.25dB F_{MIN} at 12GHz
- +32dBm Output IP3 at 12GHz
- +20dBm Output Power at 1dB Compression

Applications

- High IP3 LNA for VSAT, LMDS, Cellular Systems, and Instrumentation
- Broadband Amplifiers

Parameter	Specification			Unit	Condition		
Farameter	Min. Typ.		Max.	Unit			
Maximum Available Gain ^[2] , $Z_S=Z_S^*$, $Z_L=Z_L^*$		23		dB	Freq=1.9GHz		
	18	20	25	dB	Freq=4.0GHz		
	13	15	17	dB	Freq=12.0GHz		
Insertion Gain ^[2]	16	18	20	dB	Freq=1.9GHz, $Z_S=Z_L=50\Omega$		
Minimum Noise Figure, Z _S =Gamma-opt, Z _L =Z _L *		0.5		dB	Freq=2.0GHz		
		0.6		dB	Freq=4.0GHz		
		1.2		dB	Freq = 12.0GHz		
Output 1dB Compression Point		20.0		dBm	Freq=2.0GHz, V _{DS} =5V, I _{DS} =40mA		
		15.0		dBm	Freq=2.0GHz, V _{DS} =3V, I _{DS} =20mA		
		21		dBm	Freq=12.0GHz, V _{DS} =5V, I _{DS} =40mA		
		18		dBm	Freq=12.0GHz, V _{DS} =3V, I _{DS} =40mA		
Gain at 1dB Compression Point		17.7		dBm	Freq=2.0GHz, V _{DS} =5V, I _{DS} =40mA		
		17.0		dBm	Freq=2.0GHz, V _{DS} =3V, I _{DS} =20mA		
		13.0		dBm	Freq=12.0GHz, V _{DS} =5V, I _{DS} =40mA		
		11.0		dBm	Freq=12.0GHz, V _{DS} =3V, I _{DS} =40mA		

[1] 100% tested- DC parameters to the second of the second secon Sample tested - Samples pulled from each wafer lot. Sample test specifications are based on statistical data from sample test measurements.

[4] Test conditions: V_{DS} =3.0V, I_{DS} =20mA, T=25 °C (unless otherwise noted).

support, contact RF

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SPF-2000



Absolute Maximum Ratings

Parameter	Rating	Unit
Drain Current (I _{DS})	IDSS	mA
Forward Gate Current (I _{GSF})	0.3	mA
Reverse Gate Current (I _{GSR})	0.3	mA
Drain-to-Source Voltage (V _{DS})	+7	V
Gate-to-Drain Voltage (V _{GD})	-8	V
Gate-to-Source Voltage (V _{GS})	<-5 or >0	V
RF Input Power	100	mW
Operating Temp Range (T _{OP})	-40 to +85	°C
Storage Temp Range	-40 to +150	°C
Power Dissipation (P _{DISS})	600	mW
Channel Temp	+150	°C

Operation of this device beyond any one of these limits may cause permanent dam-Operation of this device beyond any one of these limits may cause permanent dam-age. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one. MTTF is inversely proportional to the device junction temperature. For junction tem-perature and MTTF considerations should also satisfy the following expressions: $P_{DC} - P_{OUT} < (T_j - T_L) / R_{TH}$, where $P_{DC} = I_{DS} * V_{DS}$ (W), $P_{OUT} = RF$ Output Power (W), $T_j = Junction$ Temperature (°C), $T_L = Lead$ Temperature (°C), $R_{TH} =$ Thermal Resis-tance (°C)

tance (°C/W)



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical perfor-mance or functional operation of the device under Absolute Maximum Rating condi-tions is not implied.

RoHS status based on EUDirective2002/95/EC (at time of this document revision).

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Parameter	Specification			Unit	Condition			
Falameter	Min.	Тур.	Max.	Onic	Condition			
Output Third Order Intercept Point		32		dBm	Freq=2.0GHz, V_{DS} =5V, I_{DS} =40mA			
		28		dBm	$Freq=2.0GHz, V_{DS}=3V, I_{DS}=20 mA$			
		32		dBm	$Freq=12.0GHz, V_{DS}=5V, I_{DS}=40 \text{ mA}$			
		30		dBm	$Freq=12.0GHz, V_{DS}=3V, I_{DS}=20 mA$			
Saturated Drain Current ^[2] (I _{DSS})	30	85	140	mA				
Pinch-off Voltage ^[1]	-1.5	-1.0	-0.5	V	V _{DS} =2V, I _{DS} =0.150mA			
Transconductance		112		mS	V _{GS} =-0.25V			
Gate to Source Breakdown Voltage ^[1]		-17	-8	V	I _{GS} =0.3mA, drain open			
Gate to Drain Breakdown Voltage ^[1]		-17	-8	V	I _{GS} =0.3mA, V _{GS} =-3.0V			
Thermal Resistance		110		C/W				
Operating Voltage ^[3]			5.5	V	Drain-source			
Operating Current ^[3]			55	mA	Drain-source, quiescent			
Power Dissipation ^[3]			0.2	W				

[1] 100% tested- DC parameters tested on wafer.

Sample tested - Samples pulled from each wafer lot. Sample test specifications are based on statistical data from sample test measurements. $V_{DS}*I_{DQ} < P_{DISS}$ is recommended for continuous reliable operation. [2] [3]

[4] Test conditions: V_{DS}=3.0V, I_{DS}=20mA, T=25°C (unless otherwise noted).



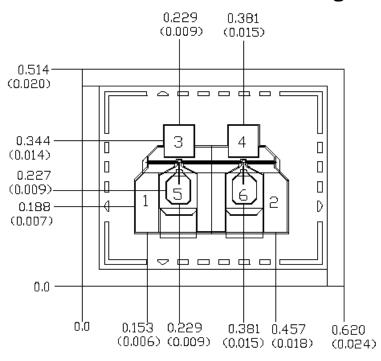


Assembly Instructions

The recommended die attach is conductive epoxy or AuSn (80/20) solder with limited exposure to temperatures at or above 300°C. The preferred wirebond method is thermo-compression wedge bond using 0.7 mil gold wire with a maximum stage temperature of 200°C. Aluminum wire should not be used.

Design Data

Complete design data including S-parameters, noise parameters, and large signal model are available upon request by contacting applications support at RFMD.com.



Mechanical Drawing

Units: millimeters (inches) Thickness: 0.1016 (0.004) Chip edge to bond pad dimensions are shown to center of bond pad Chip size tolerance: +/- 0.051 (0.002)

Bond	Pad	#1,#2	(Source)	0.056	х	0.123	(0.002	х	0.005)
Bond	Pad	#3,#4	(Drain)	0.070	×	0.074	(0,003	Х	0.003)
Bond	Pad	#5,#6	(Gate)	0.056	х	0.065	(0.002	х	0.003>

Ordering Information

Part Number	Reel Size	Devices/Reel
SPF-2000	Gel Pak	100

